



ALPHA & OMEGA
SEMICONDUCTOR, LTD

AO4435

P-Channel Enhancement Mode Field Effect Transistor

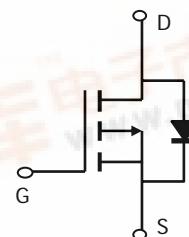
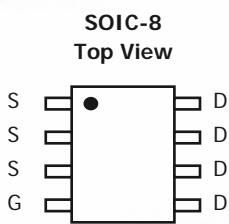


General Description

The AO4435 uses advanced trench technology to provide excellent $R_{DS(ON)}$, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. Standard Product AO4435 is Pb-free (meets ROHS & Sony 259 specifications).

Features

$V_{DS} = -30V$
 $I_D = -10A$ ($V_{GS} = -10V$)
 $R_{DS(ON)} < 18m\Omega$ ($V_{GS} = -10V$)
 $R_{DS(ON)} < 36m\Omega$ ($V_{GS} = -5V$)



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	10 Sec	Steady State	Units
Drain-Source Voltage	V_{DS}	-30		V
Gate-Source Voltage	V_{GS}	± 25		V
Continuous Drain Current ^A	I_D	-10	-8	A
$T_A=70^\circ C$		-8	-6	
Pulsed Drain Current ^B	I_{DM}	-80		
Power Dissipation ^A	P_D	3.1	1.7	W
$T_A=70^\circ C$		2.0	1.1	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	32	40	°C/W
Maximum Junction-to-Ambient ^A		60	75	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	17	24	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$			-1 -5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS} = 0\text{V}, V_{GS} = \pm 25\text{V}$			± 100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.7	-2.3	-3	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS} = -10\text{V}, V_{DS} = -5\text{V}$	-80			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = -10\text{V}, I_D = -10\text{A}$		15	18	$\text{m}\Omega$
			$T_J = 125^\circ\text{C}$	22	27	
		$V_{GS} = -5\text{V}, I_D = -5\text{A}$		27	36	
g_{FS}	Forward Transconductance	$V_{DS} = -5\text{V}, I_D = -10\text{A}$		22		S
V_{SD}	Diode Forward Voltage	$I_S = -1\text{A}, V_{GS} = 0\text{V}$		-0.74	-1	V
I_S	Maximum Body-Diode Continuous Current				-3.5	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		1130	1400	pF
C_{oss}	Output Capacitance			240		pF
C_{rss}	Reverse Transfer Capacitance			155		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		5.8	8	Ω
SWITCHING PARAMETERS						
$Q_{g(10\text{V})}$	Total Gate Charge	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-10\text{A}$		18	24	nC
$Q_{g(4.5\text{V})}$	Total Gate Charge			9.5		
Q_{gs}	Gate Source Charge			5.5		nC
Q_{gd}	Gate Drain Charge			3.3		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.5\Omega, R_{\text{GEN}}=3\Omega$		8.7		ns
t_r	Turn-On Rise Time			8.5		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			18		ns
t_f	Turn-Off Fall Time			7		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=-10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		25	30	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=-10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		12		nC

A: The value of R_{0JA} is measured with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R_{0JA} is the sum of the thermal impedance from junction to lead R_{0JL} and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < 300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The SOA curve provides a single pulse rating.

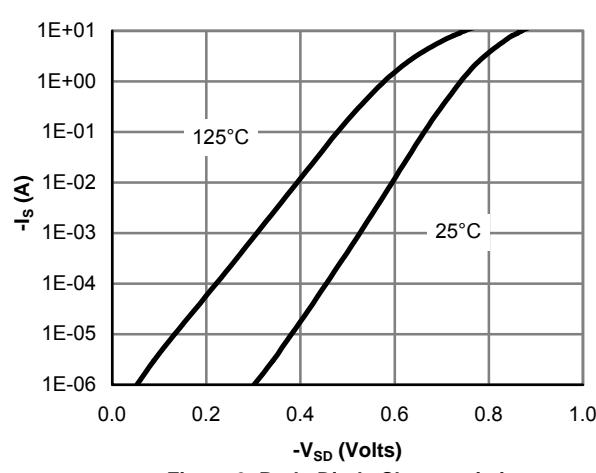
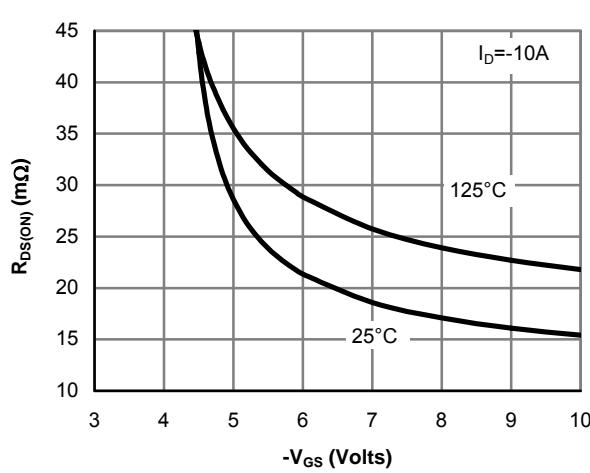
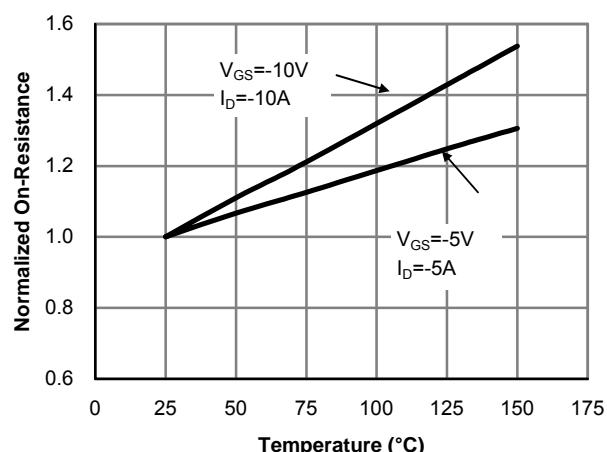
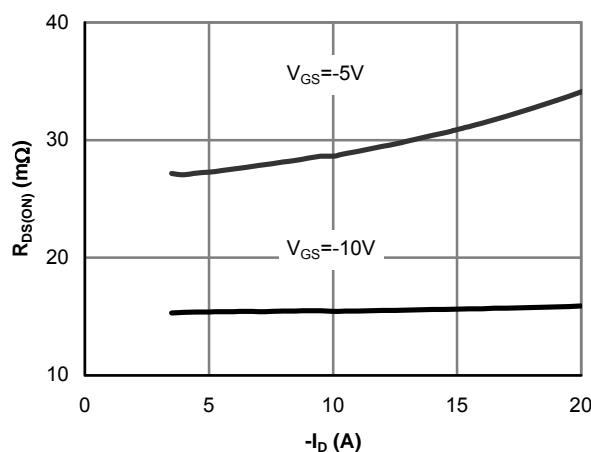
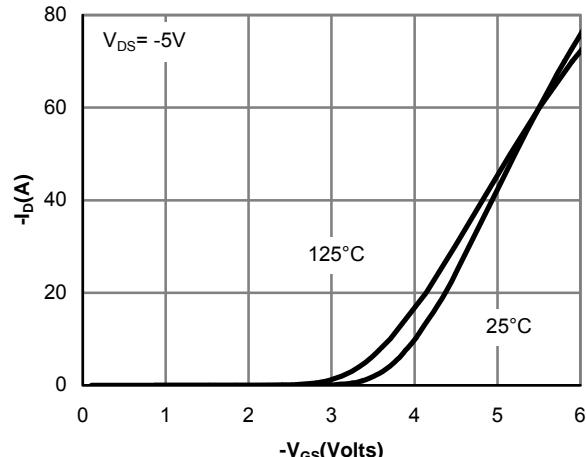
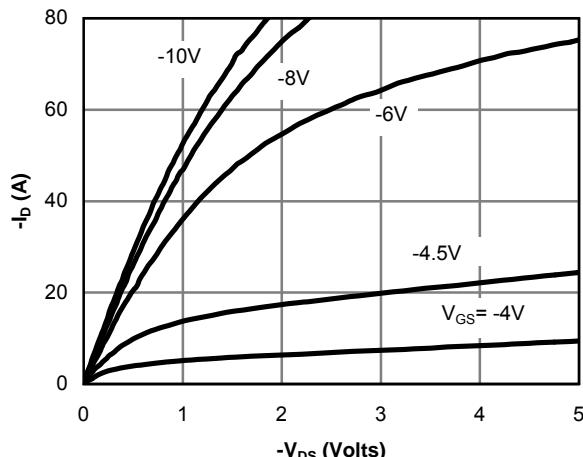
F. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep $T_J=25\text{C}$.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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